AUTOMOTIVE

ROHS

HALOGEN

FREE GREEN

(5-2008)



## Vishay Semiconductors

## Silicon PIN Photodiode



#### **DESCRIPTION**

TEMD7000X01 is a high speed and high sensitive PIN photodiode. It is a miniature surface mount device (SMD) including the chip with a 0.23 mm<sup>2</sup> sensitive area detecting visible and near infrared radiation.

#### **FEATURES**

- Package type: surface mount
- Package form: 0805
- Dimensions (L x W x H in mm): 2 x 1.25 x 0.85
- Radiant sensitive area (in mm<sup>2</sup>): 0.23
- · High photo sensitivity
- · High radiant sensitivity
- · Suitable for visible and near infrared radiation
- Fast response times
- Angle of half sensitivity:  $\phi = \pm 60^{\circ}$
- Floor life: 168 h, MSL 3, according to J-STD-020
- · Lead (Pb)-free reflow soldering
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912">www.vishay.com/doc?99912</a>



· High speed photo detector

| PRODUCT SUMMARY |                      |         |                       |  |
|-----------------|----------------------|---------|-----------------------|--|
| COMPONENT       | I <sub>ra</sub> (μΑ) | φ (deg) | λ <sub>0.1</sub> (nm) |  |
| TEMD7000X01     | 3                    | ± 60    | 350 to 1120           |  |

#### Note

· Test conditions see table "Basic Characteristics"

| ORDERING INFORMATION |               |                              |              |  |  |
|----------------------|---------------|------------------------------|--------------|--|--|
| ORDERING CODE        | PACKAGING     | REMARKS                      | PACKAGE FORM |  |  |
| TEMD7000X01          | Tape and reel | MOQ: 3000 pcs, 3000 pcs/reel | 0805         |  |  |

#### Note

· MOQ: minimum order quantity

| <b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |                                   |                   |             |      |  |
|--|-----------------------------------|-------------------|-------------|------|--|
| PARAMETER  | TEST CONDITION                    | SYMBOL            | VALUE       | UNIT |  |
| Reverse voltage  |                                   | V <sub>R</sub>    | 60          | V    |  |
| Power dissipation  | T <sub>amb</sub> ≤ 25 °C          | P <sub>V</sub>    | 215         | mW   |  |
| Junction temperature   |                                   | Tj                | 100         | °C   |  |
| Operating temperature range  |                                   | T <sub>amb</sub>  | -40 to +100 | °C   |  |
| Storage temperature range  |                                   | T <sub>stg</sub>  | -40 to +100 | °C   |  |
| Soldering temperature  | Acc. reflow solder profile fig. 8 | T <sub>sd</sub>   | 260         | °C   |  |
| Thermal resistance junction / ambient  | Acc. J-STD-051                    | R <sub>thJA</sub> | 270         | K/W  |  |

| <b>BASIC CHARACTERISTICS</b> (T <sub>amb</sub> = 25 °C, unless otherwise specified) |  |                   |      |             |      |      |
|---|--|-------------------|------|-------------|------|------|
| PARAMETER   | TEST CONDITION   | SYMBOL            | MIN. | TYP.        | MAX. | UNIT |
| Forward voltage   | I <sub>F</sub> = 50 mA   | V <sub>F</sub>    |      | 1           |      | V    |
| Breakdown voltage   | $I_R = 100 \mu A, E = 0$   | V <sub>(BR)</sub> | 60   |             |      | V    |
| Reverse dark current  | V <sub>R</sub> = 10 V, E = 0   | I <sub>ro</sub>   |      | 1           | 3    | nA   |
| Diode capacitance   | $V_R = 0 V, f = 1 MHz, E = 0$  | C <sub>D</sub>    |      | 4           |      | pF   |
|   | $V_R = 5 \text{ V}, f = 1 \text{ MHz}, E = 0$                                | C <sub>D</sub>    |      | 1.3         |      | pF   |
| Open circuit voltage  | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$                          | Vo                |      | 350         |      | mV   |
| Temperature coefficient of Vo   | $E_e = 1 \text{ mW/cm}^2, \lambda = 950 \text{ nm}$                          | TK <sub>Vo</sub>  |      | -2.6        |      | mV/K |
| Short circuit current   | $E_{e} = 1 \text{ mW/cm}^{2}, \lambda = 950 \text{ nm}$                      | l <sub>k</sub>    |      | 3           |      | μA   |
| Temperature coefficient of I <sub>k</sub>   | $E_{e} = 1 \text{ mW/cm}^{2}, \lambda = 950 \text{ nm}$                      | TK <sub>lk</sub>  |      | 0.1         |      | %/K  |
| Reverse light current   | $E_e = 1 \text{ mW/cm}^2$ , $\lambda = 950 \text{ nm}$ , $V_R = 5 \text{ V}$ | I <sub>ra</sub>   | 2.4  | 3           | 3.6  | μA   |
| Angle of half sensitivity   |  | φ                 |      | ± 60        |      | deg  |
| Wavelength of peak sensitivity  |  | $\lambda_{p}$     |      | 900         |      | nm   |
| Range of spectral bandwidth   |  | λ <sub>0.1</sub>  |      | 350 to 1120 |      | nm   |
| Rise time   | $V_R = 10 \text{ V}, R_L = 1 \text{ k}\Omega, \lambda = 820 \text{ nm}$      | t <sub>r</sub>    |      | 100         |      | ns   |
| Fall time   | $V_R = 10 \text{ V}, R_L = 1 \text{ k}\Omega, \lambda = 820 \text{ nm}$      | t <sub>f</sub>    |      | 100         |      | ns   |

## **BASIC CHARACTERISTICS** (T<sub>amb</sub> = 25 °C, unless otherwise specified)

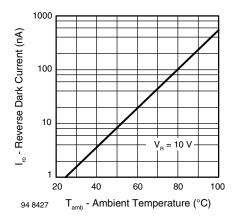


Fig. 1 - Reverse Dark Current vs. Ambient Temperature

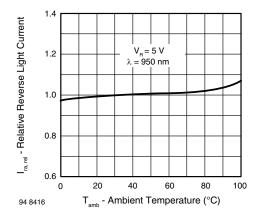


Fig. 2 - Relative Reverse Light Current vs. Ambient Temperature

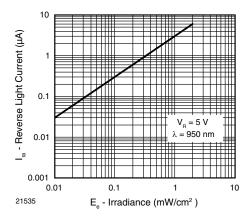


Fig. 3 - Reverse Light Current vs. Irradiance

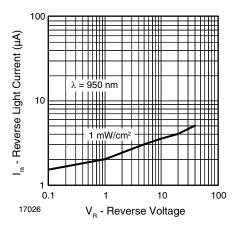


Fig. 4 - Reverse Light Current vs. Reverse Voltage

max. 260

max. 30 s

245 °C

300

250

# Vishay Semiconductors

#### **REFLOW SOLDER PROFILE**

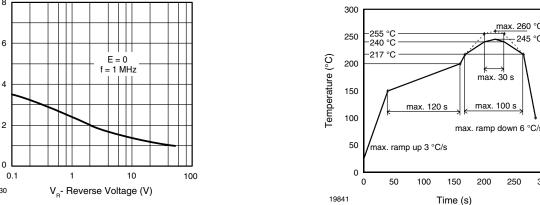


Fig. 8 - Lead (Pb)-free Reflow Solder Profile acc. J-STD-020

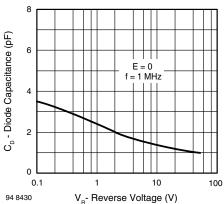


Fig. 5 - Diode Capacitance vs. Reverse Voltage

#### 1.0 0.9 0.8 0.7 0.6 0.5 0.4 0.3 0.2 0.1 400 500 600 700 800 900

Fig. 6 - Relative Spectral Sensitivity vs. Wavelength

# S(λ)<sub>rel</sub> - Relative Spectral Sensitivity 1000 1100 λ - Wavelength (nm)

0 10° 20° 30° rel - Relative Radiant Sensitivity - Angular Displacement 1.0 0.9 8.0 0.7 80 94 8013

Fig. 7 - Relative Radiant Sensitivity vs. Angular Displacement

#### **DRYPACK**

Devices are packed in moisture barrier bags (MBB) to prevent the products from moisture absorption during transportation and storage. Each bag contains a desiccant.

#### **FLOOR LIFE**

Floor life (time between soldering and removing from MBB) must not exceed the time indicated on MBB label:

Floor life: 168 h

Conditions: T<sub>amb</sub> < 30 °C, RH < 60 %

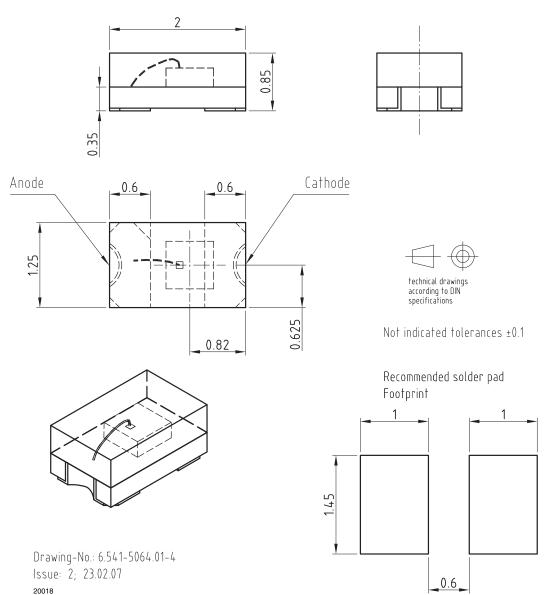
Moisture sensitivity level 3, according to J-STD-020.

#### **DRYING**

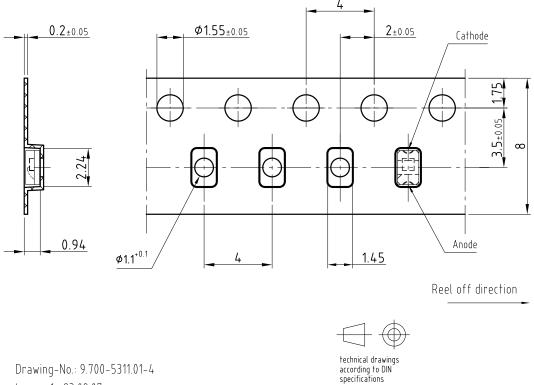
In case of moisture absorption devices should be baked before soldering. Conditions see J-STD-020 or label. Devices taped on reel dry using recommended conditions 192 h at 40 °C (+ 5 °C), RH < 5 %.



#### **PACKAGE DIMENSIONS** in millimeters



#### **BLISTER TAPE DIMENSIONS** in millimeters

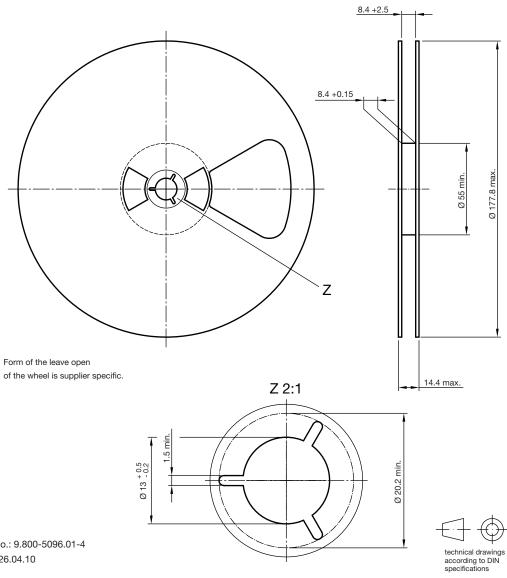


Issue: 1; 23.02.07

21501

Not indicated tolerances ±0.1

#### **REEL DIMENSIONS** in millimeters



Drawing-No.: 9.800-5096.01-4

Issue: 2; 26.04.10

20875



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